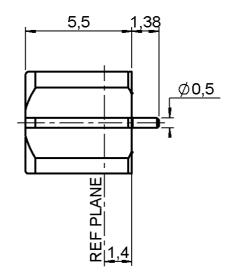
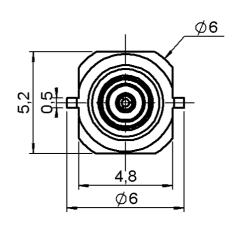
STRAIGHT JACK RECEPTACLE FOR PCB SMT TYPE - EDGE CARD

R113.423.000

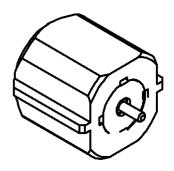
Series: MCX







Scale: 1/1



All dimensions are in mm.



COMPONENTS	MATERIALS	PLATINGS (µm)
BODY CENTER CONTACT OUTER CONTACT INSULATOR GASKET OTHERS PARTS	BRASS BERYLLIUM COPPER - PTFE	GOLD 0.2 OVER NICKEL 2 GOLD 1.3 OVER NICKEL 2 -
-	-	-

Issue: 0424 D

In the effort to improve our products, we reserve the right to make changes judged to be



STRAIGHT JACK RECEPTACLE FOR PCB

SMT TYPE - EDGE CARD

R113.423.000

Series: MCX

PACKAGING

Standard	Unit	Other
100	'W' option	Contact us

SPECIFICATION

ELECTRICAL CHARACTERISTICS

Impedance **50** Ω

Frequency **0-6** GHz

VSŴR 1.05 * +**0.015** x F(GHz) Maxi Insertion loss

0.03* $\sqrt{F(GHz)}$ dB Maxi **NA** - F(GHz)) dB Maxi RF leakage

Voltage rating 335 Veff Maxi Dielectric withstanding voltage

1000 Veff mini 1000 M Ω mini

ENVIRONMENTAL

Operating temperature -55/+155 ° C

Hermetic seal NA Atm.cm3/s

Panel leakage NA

OTHERS CHARACTERISTICS

Assembly instruction

Others:

* Coaxial Tansmission Line Only

MECHANICAL CHARACTERISTICS

Center contact retention

Insulation resistance

Axial force – Mating end 10 N mini Axial force – Opposite end 10 N mini Torque NA N.cm mini

Recommended torque

Mating NA N.cm Panel nut NA N.cm

Mating life 500 Cycles mini

Weight **0.850** g

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STRAIGHT JACK RECEPTACLE FOR PCB SMT TYPE - EDGE CARD

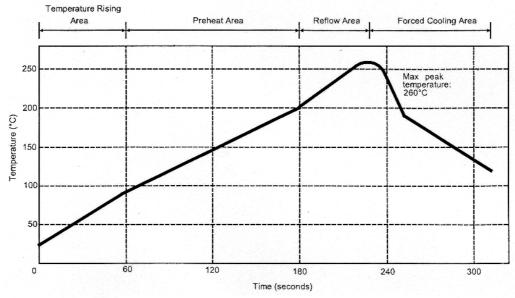
R113.423.000

Series: MCX

SOLDER PROCEDURE

- 1. Deposit solder paste 'Sn Ag4 Cu0.5' on mounting zone by screen printing application. We recommend a low residue flux.
 - We advise a thickness of 150 micromm (5.850 microinch). Verify that the edges of the zone are clean.
- 2. Placement of the receptacle on the mounting zone with an automatic machine of 'pick and place' type.
- 3. Soldering by infra-red reflow.
- 4. Cleaning of printed circuit boards.
- 5. Checking of solder joints and position of the component by visual inspection.

TEMPERATURE PROFILE



Parameter	Value	Unit
Temperature rising Area	1 - 4	°C/sec
Max Peak Temperature	260	°C
Max dwell time @260°C	10	sec
Min dwell time @235°C	20	sec
Max dwell time @235°C	60	sec
Temperature drop in cooling Area	-1 to -4	°C/sec
Max dwell time above 100°C	420	sec

Issue: 0424 D

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necessary.

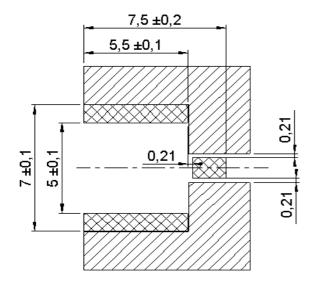


STRAIGHT JACK RECEPTACLE FOR PCB SMT TYPE - EDGE CARD

R113.423.000

Series: MCX

MCX SERIES - INFORMATIONS



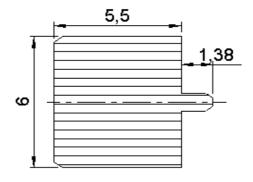


Land for solder paste

COPLANAR LINE

Pattern and signal are on the same side Thickness of PCB: 1.6mm
The material of PCB is the epoxy resin of glass fabrics bacs.(En –4.8)
The solder resist should be printed exept for the land pattern on the PCB.

SHADOW OF MCX RECEPTACLE FOR VIDEO CAMERA



Issue: 0424 D

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